



HIEC Group is a corporation creating innovative "power" with our advanced computer technology and excellent human energy.

This "power" freely combines five senses of sight, sound, touch, taste and smell with various systems to create a human-friendly future society.

You can expect much of HIEC Group's "power".

HIEC グループは先進のコンピューターテクノロジーと、卓越したヒューマンエナジーにより 新しい「チ・カ・ラ」を創造する企業です。 この「チ・カ・ラ」は人間の五感である視覚・聴覚・触覚・味覚・嗅覚と、さまざまなシステムを 自由自在に結合し、人にやさしい未来社会をつくります。

PROFILE

CompanyName

Hino Engineering Co., Ltd. / 株式会社 日野エンジニアリング

GROUP

Hino Electric Co., Ltd. / 株式会社日野電機

TEL. +81-42-646-8321 / FAX. +81-42-656-5805

CAPITAL STOCK

¥70 million / 7,000 万円

ESTABILISHED

January 23, 1978 / 昭和 53 年 1 月 23 日

REPRESENTATIVE

Masami ENDO, President / 代表取締役社長 遠藤正美

PLANT SCALE

Site Area / 敷地面積: 476 ㎡

Building Floor Space / 建物: 869.47 ㎡



HEAD OFFICE

60-7, Takakura-cho, Hachioji-shi, Tokyo 192-0033 Japan TEL. +81-42-656-1161 FAX. +81-42-656-5801



3-33-20, Toyoda, Hino-shi, Tokyo, 191-0053, Japan TEL. +81-42-843-2844 FAX. +81-42-843-2845



CHUBU OFFICE

114, Nakamichi, Yagawa-cho, Toyokawa-shi, Aichi 442-0807 Japan TEL: +81-533-65-7608 FAX: +81-533-65-7609



TAIWAN OFFICE

N FIFI D TAIWAN CO I TD

1-7-408, Goda, Okaya-shi, Nagano, 394-0021, Japan TEL: +81-266-75-013 FAX: +81-266-75-0136 台湾省台中市南屯区永春東一路 786 号 o.786, Yongchun E. 1st Rd., Nantun Dist., Taichung City 408, Taiwan (R.O.C.)



DA NANG Technical Center

UN FIELD VIETNAM CO.,LTD 16 LY THUONG KIET STREET, THACH THANG WARD, HAI CHAU DISTRICT, DA NANG CITY, VIETNAM

VIETNAM PLANT

SUWA OFFICE

SUN FIFI D VIFTNAM CO., I TD No 42, VSIP 3 STREET, VIETNAM-SINGAPORE INDUSTRIAL PARK. THUAN AN DISTRICT, BINH DUONG PROVINCE, VIETNAM



COMPANY HISTORY

1963

Hino Electric was founded as a subcontract factory of Fuji Electric Manufacturing (present name: Fuii Electric Systems).

富士電機製造(現富士電機システムズ)の協力工場として日野電機を発足



Hino Engineering was founded focusing on design and development.

設計開発に重点をおいた日野エンジニアリングを発足

1995

1978

Started selling NEC 98 series compatible FA computers "MultiFlex"; Advanced into FA computer industry NEC98 シリーズ互換 FA コンピュータ「MultiFlex」販売、FA コンピュータ業界に進出

2000

Started selling DOS/V compatible panel computers; Switched to DOS/V compatible devices DOS/V 互換パネルコンピュータ「MultiFlexP」販売、DOS/V 互換機への転換

2003

Developed "CABG Treatment Control System" with Nihon University and University of Tsukuba as an industry-academia-government project 産学公プロジェクトとして日本大学・筑波大学と「CABG 治療統轄システム」を開発

Designated as business receiving subsidies for developing new products/technologies of Tokyo

東京都新製品・新技術開発助成事業の対象となる

2004

Acquired ISO 9001 ISO 9001 取得

2008

Set up Suwa Office. Worked on manufacture and assembly of precision machined parts 諏訪事業所を開設 精密加工部品製造、組立事業に取り組む

2009

Established "SUN FIELD VIETNAM CO., LTD." in Ho Chi Minh City, Vietnam

Started operation of a plant for manufacture of plastic molded parts, board mounting lines and assembly

ベトナム国 ホーチミン市に「サンフィールドベトナム」を設立し、樹脂成形部品の製造、基板実装ライン・組立の工場を操業

Established procurement route in Taiwan

台湾調達ルートを確立 Set up Chubu Office

中部事業所を開設

2010

Established "日野工程科技股份有限公司" in Taiwan 台湾に「日野工程科技股份有限公司」を設立

2012

Started KES activities

KES活動を開始

2013

Acquired KES Environmental Management System Standard

2015

New plant in Vietnam was launched

ベトナム新工場を竣工

2016

Opened Sales&Technology Center 営業・技術センターを開設

2018

Due to expanding business, Sales & Technology Center moved and renamed Hino Technical Center 事業拡大に伴い営業・技術センターを移転し、日野テクニカルセンターに名称変更

Sun Field Vietnam Danang Technical Center opened

Due to expanding business, Chubu Office renamed Chubu Branch

Start of construction on Sun Field Vietnam extension

ELECTRONICS DIVISION

We provide optimum solutions to customers' needs making full use of our embedded CPU development technologies, camera development technologies, control panel system development technologies and board mounting technologies.

組込み CPU 開発技術、カメラ開発技術、コントロールパネルシステム開発技術、 基板実装技術を駆使してお客様のニーズに最適なソリューションを提供します。

> TOTAL TECHNOLOGICAL STRENGTH Collaboration with universities, research institutions, and companies

PROJECT MANAGEMENT
Guarantee reliability of quality,
costs, delivery dates, etc.

ADVANCED TECHNOLOGICAL APPLICATION

Make use of latest advanced technologies
in various fields

TOTAL SOLUTIONS

CUSTOMIZED COMPUTERS Establish optimum systems with various partners

ISO9001:2000

Technologies with consistently high quality from development to manufacture

LIFE CYCLE SUPPORT

Contribute to improvements in price over system life cycles

EMS Service

Prototype development \cdot Various small quantity \cdot Short delivery time Production is Hachioji head office factory, mass production product is Vietnam factory. We will respond to customer's needs accordingly.

In addition, we will use Hino Engineering Network to procure all parts from domestic and foreign electronic parts to metal and resin processed goods.

試作開発・多種少量・短納期生産は八王子本社工場、量産品はベトナム工場。 お客様のニーズに併せてご対応いたします。 また、日野エンジニアリングネットワークを駆使し、 国内外の電子部品から金属・樹脂加工品まですべて調達いたします。



Multi Flex®

"MultiFlex®", Hino Engineering's original brand, is a series of computer boards, camera modules and IoT communication modules specifically for industrial embedded devices. All products in the "MultiFlex®" series can be customized according to the customer's specifications. We offer high quality products with I ong-lasting reliability.

日野エンジニアリングオリジナルブランド "MultiFlex®"series は産業用 組込機器向けに特化したコンピューターボード、カメラモジュール、 IoT 通信モジュールです。すべての "MultiFlex®"series はお客様の仕様に 併せてカスタマイズが可能です。 長期に渡り安心してお使い頂ける 高品質な製品を提供いたします。

Multi Flex。CAMERA

Multi FlexCAM-M20C

High quality camera module with SONY image sensor and ISP

SONY製イメージセンサとISP搭載の高画質カメラモジュール



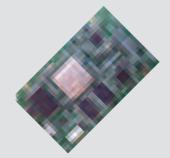
Built-in camera module that condenses high performance and high image quality into an ultra compact size. It can be safely used for industrial equipment compatible with small lot customization.

高性能と高画質を超小型サイズに凝縮した内蔵カメラモジュール。 小ロットカスタマイズ対応の産業機器に安全に使用できます。

Multi Flex_®CPU

Multi Flex-A9

NXP®/ i MX 6 ARM Cortex™-A9 Quad/Dual/Solo



Multiflex Series Computer is a board computer equipped with processor featuring high speed, low power consumption and low price that is compatible with a wide range of consumer, industrial and automotive applications based on ARM core technology.

Multiflex シリーズコンピュータは、ARM コアテクノロジをベースにしたさまざまな 民生用、産業用および自動車用アプリケーションと互換性のある、高速、低消費電力、 および低価格を特長とするプロセッサを搭載したボードコンピュータです。

Multi Flex_® loT



SIGFOX MODULE Make all machines IoT.

MF-LPWA-SIG-TS
Built-in Cortex®-M0+

Complies with Radio Law and RCZ4 standards Low current consumption design: Less than

 2μ at standby

Equipped with general-purpose microcomputer interfaces (GPIO, UART, SPI, ADC and I2C)

Cortex®-M0+ 内蔵 電波法・RCZ4 規格に対応 スタンバイ時 2 µ A 以下の低消費電流設計 汎用マイコンインターフェイス (GPIO・UART・SPI・ADC・I2C) 搭載

An image recognition solution achieved through a combination of the ARM Cortex-A9 CPU and a CAMERA module.

ARM Cortex-A9CPU とカメラモジュールのコラボレーションによる 画像認識ソリューションを実現しました。



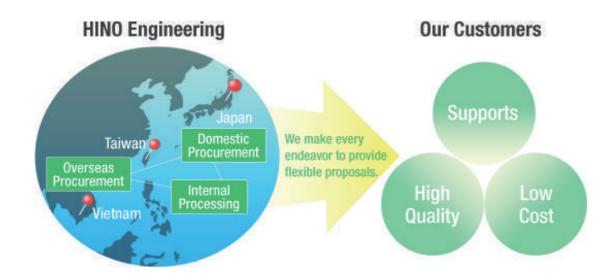
Full-HD(2 million pixels) 30fpa
1/2.8" CMOS ImageSensor
CPU Quad 1GHz • DDR3 2GB • NAND 4GB
OpenCV,Qt Library
Web Servwer
Various interfaces installed

For details please also visit our website

PROCESSING DIVISION

We thoroughly pursue lower cost and higher quality and procure products satisfying customers' requirements to provide parts and products sought by Japanese corporations at desired cost and quality. Our procurement of processed parts covers both in Japan and overseas to satisfy various customers' requirements and, together with parts processing and assembly at our Vietnam Plant, can provide optimum solution to every custom case.

お客様のご要望にお応えするため、国内外を問わない加工部品調達をおこなっておりお求めになるコスト・ 品質を徹底的に追求し、ご提供いたします。自社ベトナム工場では、部品調達・加工・組立まで一貫して 対応できますので、あらゆるカスタム案件に最適です。



AVAILABLE PRODUCTS

Plastic molded parts (up to 800 t)

樹脂形成部品(800tまで)

Aluminum die cast parts (up to 800 t)

アルミダイキャスト部品(800t まで)

Aluminum extruded parts (up to 1600 t)

アルミ押し出し加工部品(1600t まで)

Pressed metal parts (up to 500 t)

金属プレス加工(500tまで)

Machined metal parts

金属機械加工

Harness assemblies

ハーネス組立加工

Molded jigs and tools 各種治工具金型部品加工

Rubbers, screws

ゴム・ねじ類加工



















TAIWAN OFFICE (日野工程科技股份有限公司)

We established our procurement route in Taiwan through our local staffs. Pressed parts, molded parts, die cast parts, cutting parts, electronic parts, printed circuit boards, harnesses, and assemblies are available.

・ プレス、整形部品、ダイキャスト、切削部品、電子部品、プリント基板、ハーネス、A s s y 品を調達いたします。



SUN FIELD VIETNAM CO.,LTD

We established our own plant "SUN FIELD VIETNAM CO., LTD." in Vietnam-Singapore Industrial Park (VSIP) in Ho Chi Minh City, Vietnam in 2009. A great deal of processing and manufacture have been taken place.

VSIP is located in BinhDuong Province at about 17 km from Ho Chi Minh City, and readily accessible from Tan Son Nhat International Airport and Harbor. VSIP is an industrial park with a good environment having its own power supply and well-developed infrastructures such as electricity, transport, living and communication.

We can offer low-cost and high-quality products with our plant for manufacture of plastic molded parts, board mounting lines and parts assembly and with young manpower in Vietnam and reliable techniques from Japan.

Tie-up between our Head Office and Vietnam Plant allows "consistent services from design to manufacture" and parts procurement for every project of HINO Engineering Group.

VSIP はホーチミン市から約 17km 離れたビンズン省にあり 設立し、ベトナムの若い労働力と日本からの確かな技術 本社とタイアップする事で「設計から製造まで一貫して」対応 可能な上、日野エンジニアリンググループ各事業に向けて部品



